INTEGRATED CIRCUITS

DATA SHEET

74F08Quad two-input AND gate

Product specification

1995 Apr 19

IC15 Data Handbook

Philips Semiconductors





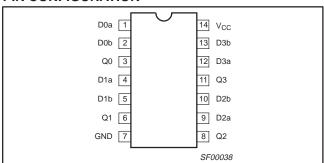
Quad 2-input AND gate

74F08

• 74F08 Available for industrial range (-40°C to +85°C)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F08	4.1ns	7.1mA

PIN CONFIGURATION



ORDERING INFORMATION

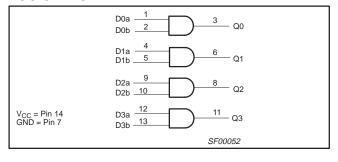
DESCRIPTION	COMMERCIAL RANGE $V_{CC} = 5.0V \pm 10\%, T_{amb} = 0^{\circ}\text{C to } +70^{\circ}\text{C}$	INDUSTRIAL RANGE V_{CC} = 5.0V $\pm 10\%$, T_{amb} = -40° C to $+85^{\circ}$ C	PKG DWG#
14-pin plastic DIP	N74F08N	I74F08N	SOT27-1
14-pin plastic SO	N74F08D	I74F08D	SOT108-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb	Data inputs	1.0/1.0	20μA/0.6mA
Qn	Data output	50/33	1.0mA/20mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC DIAGRAM



FUNCTION TABLE

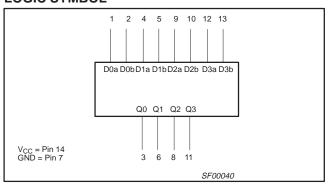
INP	UTS	OUTPUT
Dna	Dnb	Qn
L	L	L
L	Н	L
Н	L	L
Н	Н	Н

NOTES:

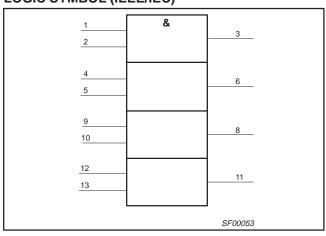
H = High voltage level

L = Low voltage level

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current		-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state		–0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state		40	mA
_		Commercial range	0 to +70	°C
l amb	Operating free-air temperature range	-40 to +85	°C	
T _{stg}	Storage temperature range	-65 to +150	°C	

RECOMMENDED OPERATING CONDITIONS

CVMDOL	PARAMETER			LIMITS		LINUT
SYMBOL	PARAMETER		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{Ih}	High-level input voltage		2.0			V
V _{IL}	Low-level input voltage			0.8	V	
I _{IK}	Input clamp current				-18	mA
I _{OH}	High-level output current				-1	mA
I _{OL}	Low-level output current				20	mA
т.	Operating free-air temperature range	Commercial range	0		+70	°C
lamb	Operating nee-all temperature range	Industrial range	-40		+85	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

OVMDOL	DADAMETED		TEGT CONDITIO	NO1		LIMITS		
SYMBOL	PARAMETER		TEST CONDITIO	ONO'	MIN	TYP ²	MAX	UNIT
V	High-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}	2.5			V
V _{OH}	High-level output voltage		V _{IH} = MIN, I _{OH} = MAX	±5%V _{CC}	2.7	3.4		V
V	Low lovel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.30	0.50	V
V _{OL}	Low-level output voltage		$V_{IH} = MIN, I_{OI} = MAX$ $\pm 5\% V_{CC}$			0.30	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V	
I _I	Input current at maximum voltage	input	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I _{IL}	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA
I _{OS}	Short-circuit output current ³		V _{CC} = MAX		-60		-150	mA
la a	Supply ourrent (total)		$V_{CC} = MAX$ $V_{IN} = 4.5V$			5.5	8.3	mA
Icc	Supply current (total)		$V_{CC} = MAX$	V _{IN} = GND		8.6	12.9	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.

^{3.} Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

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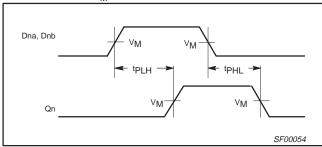
74F08

AC ELECTRICAL CHARACTERISTICS

		TEST CONDITION		LIMITS								
SYMBOL	PARAMETER		T_{amb} = +25°C V_{CC} = +5.0V C_L = 50pF, R_L = 500 Ω			V _{CC} = +5. C _L =	C to +70°C 0V ± 10% 50pF, 500Ω	T _{amb} = -40° V _{CC} = +5. C _L = : R _L =	UNIT			
			MIN	TYP	MAX	MIN	MAX	MIN	MAX			
t _{PLH} t _{PHL}	Propagation delay Dna, Dnb to Qn	Waveform 1	3.0 2.5	4.2 4.0	5.6 5.3	3.0 2.5	6.6 6.3	2.5 2.5	6.6 6.3	ns		

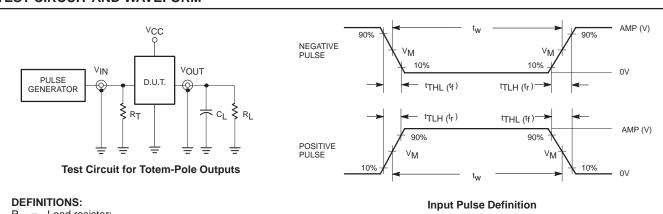
AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.



Waveform 1. Propagation Delay for Non-Inverting Outputs

TEST CIRCUIT AND WAVEFORM



 R_L = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

Termination resistance should be equal to Z_{OUT} of pulse generators.

family	INP	INPUT PULSE REQUIREMENTS											
	amplitude	V _M rep. rate t _w t _{TLH}											
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns							

SF00006

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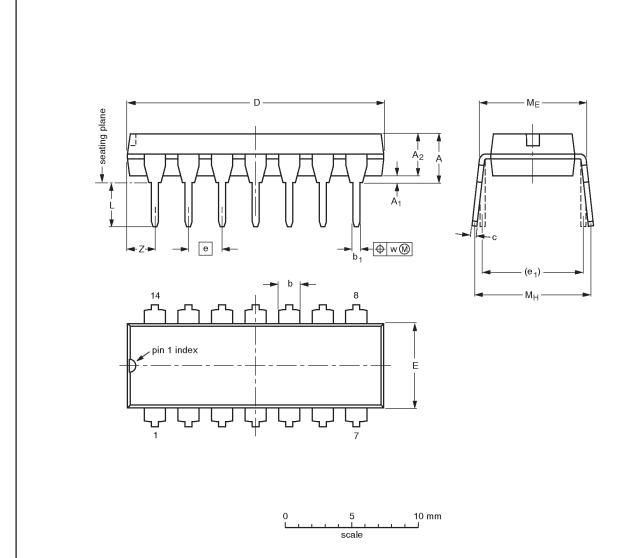
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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	PROJECTION	ISSUE DATE		
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

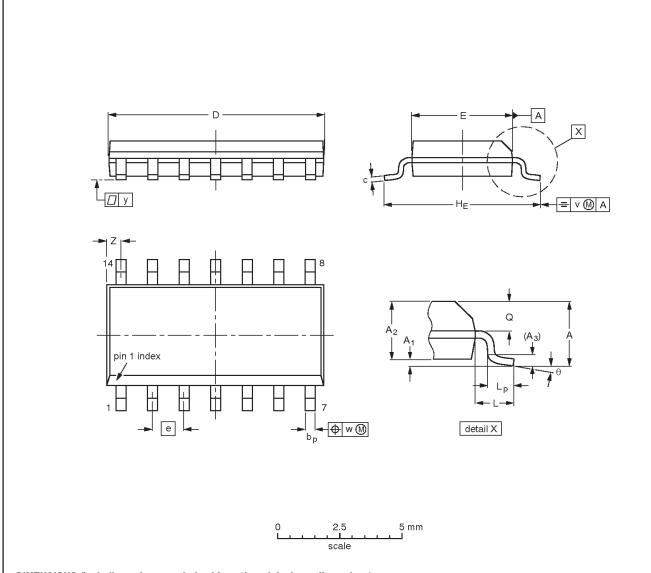
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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN PROJECTION	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ			1990E DATE
SOT108-1	076E06S	MS-012AB				95-01-23 97-05-22

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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